VS-ST230C Series

Vishay Semiconductors

RoHS

COMPLIANT



Phase Control Thyristors (Hockey PUK Version), 410 A



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PRIMARY CHARACTERISTICS								
I _{T(AV)}	410 A							
V _{DRM} /V _{RRM}	400 V, 800 V, 1200 V, 1400 V, 1600 V, 1800 V, 2000 V							
V _{TM}	1.69 V							
I _{GT}	90 mA							
TJ	-40 °C to +125 °C							
Package	A-PUK (TO-200AB)							

Single SCR

FEATURES

- Center amplifying gate
- Metal case with ceramic insulator
- International standard case A-PUK (TO-200AB)
- Designed and qualified for industrial level
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

- DC motor controls
- Controlled DC power supplies
- AC controllers

MAJOR RATINGS AND CHARACTERISTICS								
PARAMETER	TEST CONDITIONS	VALUES	UNITS					
I		410	A					
I _{T(AV)}	T _{hs}	55	°C					
I _{T(RMS)}		780	A					
	T _{hs}	25	°C					
1	50 Hz	5700						
ITSM	60 Hz	5970	- A					
l ² t	50 Hz	163	1.42					
1-1	60 Hz	149	– kA ² s					
V _{DRM} /V _{RRM}		400 to 2000	V					
tq	Typical	100	μs					
TJ		-40 to +125	°C					

ELECTRICAL SPECIFICATIONS

Circuit configuration

VOLTAGE RATINGS								
TYPE NUMBER	VOLTAGE CODE	V _{DRM} /V _{RRM} , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK VOLTAGE V	I _{DRM} /I _{RRM,} MAXIMUM AT T _J = T _J MAXIMUM mA				
	04	400	500					
	08	800	900					
	12	1200	1300					
VS-ST230CC	14	1400	1500	30				
	16	1600	1700					
	18	1800	1900					
	20	2000	2100					

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ABSOLUTE MAXIMUM RATINGS								
PARAMETER	SYMBOL		TEST CONDITIONS					
Maximum average on-state current	L	180° condu	ction, half sine v	wave	410 (165)	Α		
at heatsink temperature	I _{T(AV)}	double side	(single side) co	oled	55 (85)	°C		
Maximum RMS on-state current	I _{T(RMS)}	DC at 25 °C	heatsink temp	erature double side cooled	780			
		t = 10 ms	No voltage		5700			
Maximum peak, one-cycle	l	t = 8.3 ms	reapplied		5970	А		
non-repetitive surge current	I _{TSM}	t = 10 ms	100 % V _{RRM}		4800	kA ² s		
		t = 8.3 ms	reapplied	Sinusoidal half wave,	5000			
	l ² t	t = 10 ms	No voltage reapplied	initial $T_J = T_J$ maximum	163			
Maximum I ² t for fusing		t = 8.3 ms			148			
Maximum - t for fusing		t = 10 ms	100 % V _{RRM}		115			
		t = 8.3 ms	reapplied		105			
Maximum I ² √t for fusing	l²√t	t = 0.1 to 10) ms, no voltage	e reapplied	1630	kA²√s		
Low level value of threshold voltage	V _{T(TO)1}	(16.7 % x π	$x \ I_{T(AV)} < I < \pi \ x$	$I_{T(AV)}$), $T_{J} = T_{J}$ maximum	0.92	V		
High level value of threshold voltage	V _{T(TO)2}	$(I > \pi \times I_{T(AV)})$	$(I > \pi \times I_{T(AV)}), T_J = T_J maximum$			v		
Low level value of on-state slope resistance	r _{t1}	(16.7 % x π x I _{T(AV)} < I < π x I _{T(AV)}), T _J = T _J maximum			0.88	mΩ		
High level value of on-state slope resistance	r _{t2}	$(I > \pi \times I_{T(AV)}), T_J = T_J maximum$			0.81	1115.2		
Maximum on-state voltage	V_{TM}	$I_{pk} = 880 \text{ A}, T_J = T_J \text{ maximum, } t_p = 10 \text{ ms sine pulse}$			1.69	V		
Maximum holding current	Ι _Η	T _ 25 °C	anada ayanlıy 1	2.V registive load	600	mA		
Maximum (typical) latching current	١L	ij=25 C,	anoue supply 1	2 V resistive load	1000 (300)	IIIA		

SWITCHING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum non-repetitive rate of rise of turned-on current	dl/dt	Gate drive 20 V, 20 $\Omega,t_r \leq 1~\mu s$ T_J = T_J maximum, anode voltage $\leq 80~\%~V_{DRM}$	1000	A/µs
Typical delay time	t _d	Gate current 1 A, dl _g /dt = 1 A/ μ s V _d = 0.67 % V _{DRM} , T _J = 25 °C	1.0	
Typical turn-off time	tq	I_{TM} = 300 A, T_J = T_J maximum, dl/dt = 20 A/µs, V_R = 50 V, dV/dt = 20 V/µs, gate 0 V 100 $\Omega,$ t_p = 500 µs	100	μs

BLOCKING									
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS					
Maximum critical rate of rise of off-state voltage	dV/dt	$T_J = T_J$ maximum linear to 80 % rated V_{DRM}	500	V/µs					
Maximum peak reverse and off-state leakage current	I _{RRM} , I _{DRM}	$T_J = T_J$ maximum, rated V_{DRM}/V_{RRM} applied	30	mA					



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TRIGGERING							
PABAMETER	SYMBOL	те	ST CONDITIONS	VAL	UNITS		
PANAIVIETEN	STNIBOL	16	STEENDITIONS	TYP.	MAX.		
Maximum peak gate power	P _{GM}	$T_J = T_J$ maximum,	, $t_p \le 5 \text{ ms}$	10).0	w	
Maximum average gate power	P _{G(AV)}	$T_J = T_J$ maximum,	, f = 50 Hz, d% = 50	2	.0	vv	
Maximum peak positive gate current	I _{GM}	$T_J = T_J$ maximum,	, t _p ≤ 5 ms	3	.0	А	
Maximum peak positive gate voltage	+ V _{GM}	T. – T. movimum	t < 5 mg	2	0	v	
Maximum peak negative gate voltage	- V _{GM}	ij = ij maximum,	$T_J = T_J$ maximum, $t_p \le 5$ ms			v	
	I _{GT}	T _J = - 40 °C		180	-		
DC gate current required to trigger		T _J = 25 °C	Maximum required gate trigger/	90	150	mA	
		T _J = 125 °C	current/voltage are the lowest	40	-		
		$T_J = -40 \ ^{\circ}C$ value which will trigger all u		2.9	-		
DC gate voltage required to trigger	V _{GT}	T _J = 25 °C	12 V anode to cathode applied	1.8	3.0	V	
		T _J = 125 °C		1.2	-		
DC gate current not to trigger	I _{GD}	Maximum gate current/vc		10		mA	
DC gate voltage not to trigger	V _{GD}	T _J = T _J maximum	not to trigger is the maximum value which will not trigger any unit with rated V _{DRM} anode to cathode applied	0.25		V	

THERMAL AND MECHANICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum operating temperature range	TJ		-40 to 125	°C				
Maximum storage temperature range	T _{Stg}		-40 to 150					
Maximum thermal resistance,	Р	DC operation single side cooled	0.17					
junction to heatsink	R _{thJ-hs}	DC operation double side cooled	0.08	к/w				
Maximum thermal resistance,	D	DC operation single side cooled	0.033	r\/ vv				
case to heatsink	R _{thC-hs}	DC operation double side cooled	0.017					
Mounting force, ± 10 %			4900 (500)	N (kg)				
Approximate weight			50	g				
Case style		See dimensions - link at the end of datasheet	A-PUK (TO-2	200AB)				

$\Delta \mathbf{R}_{\text{thJC}}$ CONDUCTION						
	SINUSOIDAL	CONDUCTION	RECTANGULAR	R CONDUCTION	TEST CONDITIONS	UNITS
CONDUCTION ANGLE	SINGLE SIDE	DOUBLE SIDE	SINGLE SIDE	DOUBLE SIDE	TEST CONDITIONS	UNITS
180°	0.015	0.017	0.011	0.011		
120°	0.018	0.019	0.019	0.019		
90°	0.024	0.024	0.026	0.026	$T_J = T_J maximum$	K/W
60°	0.035	0.035	0.036	0.036		
30°	0.060	0.060	0.060	0.061		

Note

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• The table above shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC



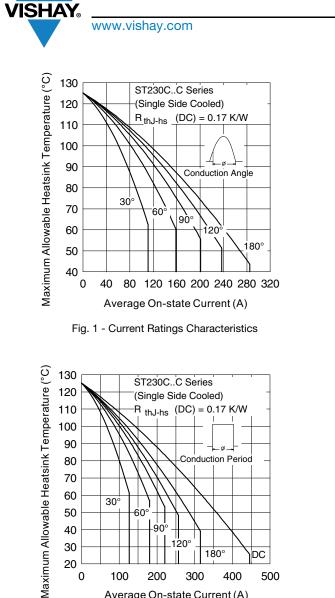


Fig. 2 - Current Ratings Characteristics

Average On-state Current (A)

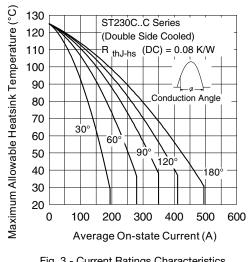


Fig. 3 - Current Ratings Characteristics

Maximum Allowable Heatsink Temperature (°C) 130 ST230C..C Series 120 (Double Side Cooled) 110 (DC) = 0.08 K/W thJ-hs 100 90 Conduction Period 80 70 30 60 60 50 120 40 180 30 ĎС 20 100 200 300 400 500 600 700 800 0 Average On-state Current (A)

Fig. 4 - Current Ratings Characteristics

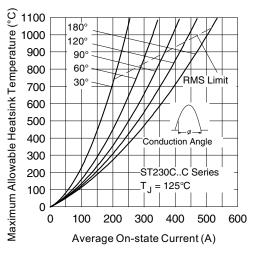


Fig. 5 - On-State Power Loss Characteristics

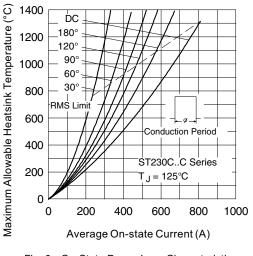
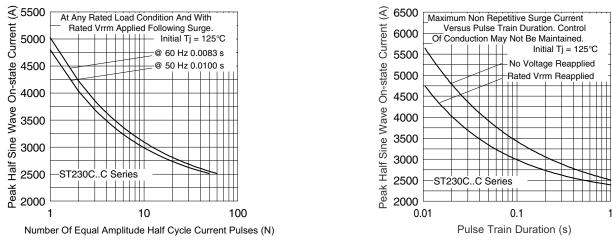


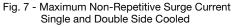
Fig. 6 - On-State Power Loss Characteristics

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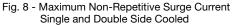
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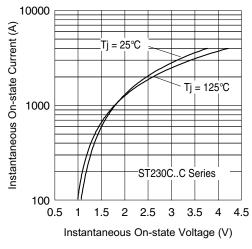
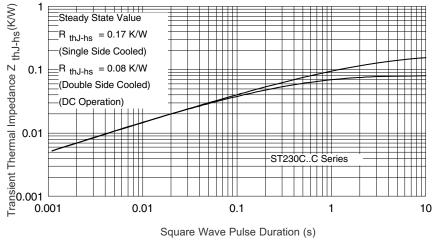


Fig. 9 - On-State Voltage Drop Characteristics





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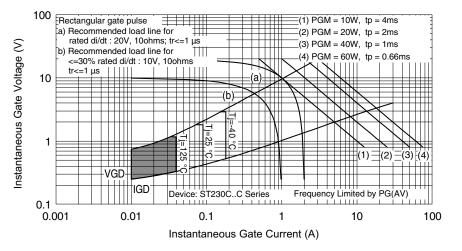


Fig. 11 - Gate Characteristics

ORDERING INFORMATION TABLE

www.vishay.com

Device code	vs-	ST	23	0	С	20	С	1	-		
	1	2	3	4	5	6	7	8	9	I	
	 Vishay Semiconductors product Thyristor Essential part number 0 = converter grade C = ceramic PUK Voltage code x 100 = V_{RRM} (see Voltage Ratings table) C = PUK case A-PUK (TO-200AB) 0 = eyelet terminals (gate and auxiliary cathode unsoldered 									,	
	9 -	2 = 3 =	 0 = eyelet terminals (gate and auxiliary cathode unsoldered leads) 1 = fast-on terminals (gate and auxiliary cathode unsoldered leads) 2 = eyelet terminals (gate and auxiliary cathode soldered leads) 3 = fast-on terminals (gate and auxiliary cathode soldered leads) Critical dV/dt: • None = 500 V/µs (standard selection) • L = 1000 V/µs (special selection) 								

LINKS TO RELATED DOCUMENTS	
Dimensions	www.vishay.com/doc?95074



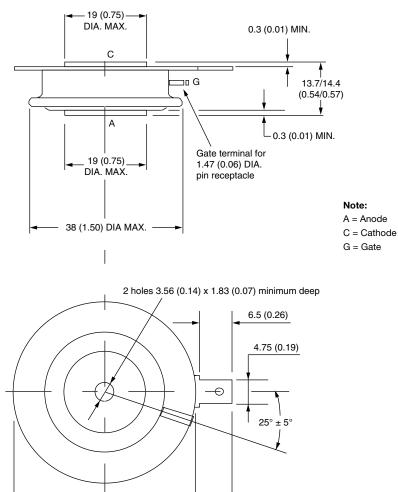


A-PUK (TO-200AB)

DIMENSIONS in millimeters (inches)

Anode to gate

Creepage distance: 7.62 (0.30) minimum Strike distance: 7.12 (0.28) minimum



42 (1.65) MAX. 28 (1.10)

Quote between upper and lower pole pieces has to be considered after application of mounting force (see thermal and mechanical specification)



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